



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
04	00) (1.7Ω @ V _{GS} = 10V	500mA
Q	Q1 60V	3Ω @ V_{GS} = 4.5 V	400mA
00	2017	4Ω @ V _{GS} = -10V	-360mA
Q2	-60V	6Ω @ V _{GS} = -4.5V	-310mA

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

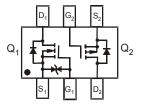
Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (approximate)



Top View

Bottom View



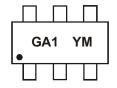
Ordering Information (Note 4 & 5)

Part Number	Compliance	Case	Packaging
DMG1029SV-7	Standard	SOT563	3000/Tape & Reel
DMG1029SVQ-7	Automotive	SOT563	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.

Marking Information



GA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

Date Code Key

Year	200	9	2010		2011	20)12	2013		2014		2015
Code	W		X		Υ		Z	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage			V_{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Dusin Courset (Nata 7) V = 40 V	Steady State	T _A = +25°C T _A = +70°C	ID	500 400	mA
Continuous Drain Current (Note 7) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	I _D	620 480	mA
Pulsed Drain Current (Note 7)		I _{DM}	1000	mA	

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage			V_{DSS}	-60	V
Gate-Source Voltage		V_{GSS}	±20	V	
Continuous Drain Correct (Nato 7) V - 40 V	Steady State	T _A = +25°C T _A = +70°C	I _D	-360 -280	mA
Continuous Drain Current (Note 7) V _{GS} = -10V	t<10s	T _A = +25°C T _A = +70°C	l _D	-410 -320	mA
Pulsed Drain Current (Note 7)		I _{DM}	-650	mA	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 6)	T _A = +25°C	Б	0.45	W	
Total Fower Dissipation (Note 6)	T _A = +70°C	P_D	0.28		
Thermal Peciatanes, Junction to Ambient (Note 6)	Steady state	Б	281	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ hetaJA}$	210		
Total Dawar Dissination (Note 7)	T _A = +25°C	Б	1	W	
Total Power Dissipation (Note 7)	T _A = +70°C	P _D	0.62		
Thermal Decistance, Junction to Ambient (Note 7)	Steady state	-	129	°C/W	
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{ hetaJA}$	97	C/VV	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Notes:

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL – Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	_	1	10	nA	V _{DS} =50V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±50	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1.0		2.5	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	J	_	1.3	1.7	Ω	V _{GS} = 10V, I _D = 500mA
Static Diain-Source On-Resistance	R _{DS(ON)}	_	1.5	3	12	V_{GS} = 4.5V, I_{D} = 200mA
Forward Transfer Admittance		80	_	_	mS	V _{DS} = 10V, I _D = 200mA
Diode Forward Voltage	V_{SD}	_	_	1.4	V	V _{GS} = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	30	_	pF	.,
Output Capacitance	Coss	_	4.2	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.9	_	pF	1 - 1.000112
Total Gate Charge	Qg	_	0.3	_	nC	.,
Gate-Source Charge	Qgs	_	0.2	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge		_	0.08	_	nC	- ID - 230IIIA
Turn-On Delay Time		_	3.9	_	ns	
Turn-On Rise Time	t _{D(on)}	_	3.4	_	ns	V _{DD} = 30V, V _{GS} = 10V,
Turn-Off Delay Time		_	15.7	_	ns	$R_G = 25\Omega$, $I_D = 200mA$
Turn-Off Fall Time	t _f	_	9.9	_	ns	

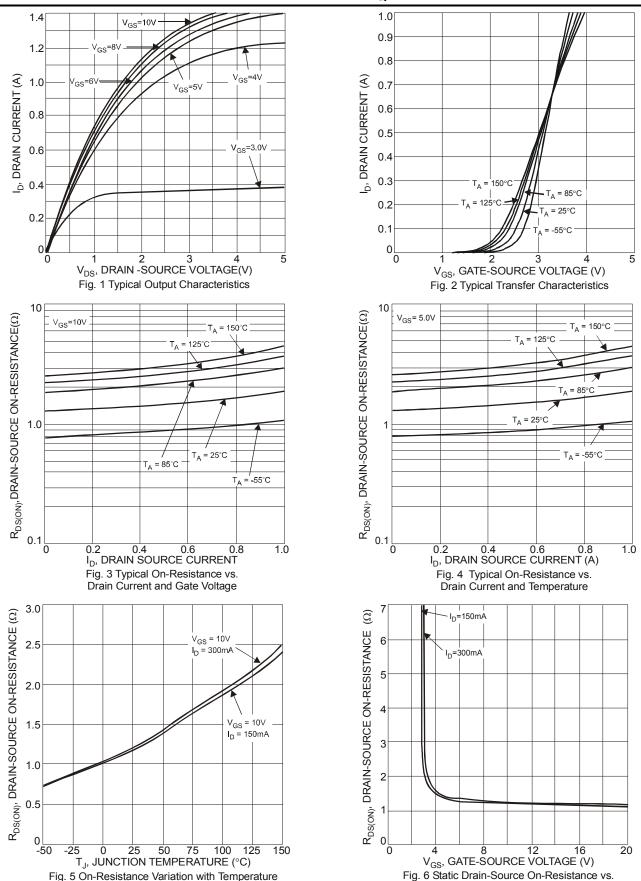
Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-60	_	_	٧	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	1	_	-25	nA	$V_{DS} = -50V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)					_	
Gate Threshold Voltage	V _{GS(th)}	-1	_	-3.0	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	D	1	2.7	4	Ω	$V_{GS} = -10V, I_D = -500mA$
Static Dialit-Source Off-Resistance	R _{DS (ON)}	1	3.2	6	22	V_{GS} = -4.5V, I_{D} = -200mA
Forward Transfer Admittance	Y _{fs}	50	_	_	mS	$V_{DS} = -25V, I_{D} = -100mA$
Diode Forward Voltage	V _{SD}	_	_	-1.4	V	$V_{GS} = 0V, I_{S} = -115mA$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	1	25	_	pF	.,
Output Capacitance	Coss	1	4.7	_	pF	$V_{DS} = -25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	1	2.7	_	pF	1 - 1.00112
Total Gate Charge	Qg		0.28	_	nC	45)/)/ 40)/
Gate-Source Charge	Q_{gs}	_	0.14	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$ - $I_{D} = -500$ mA
Gate-Drain Charge	Q_{gd}	_	0.08	_	nC	- 1D300111A
Turn-On Delay Time	t _{D(on)}		5.5	_	ns	
Turn-On Rise Time	t _r	1	7.9	_	ns	$V_{DD} = -30V, V_{GS} = -10V,$
Turn-Off Delay Time		_	10.6	_	ns	$R_G = 50\Omega$, $I_D = -270$ mA
Turn-Off Fall Time	t _f	_	11.6	_	ns	

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:

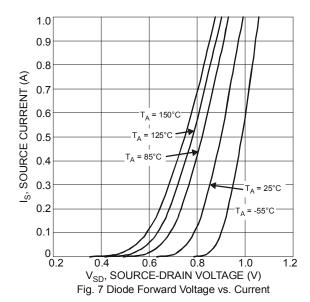


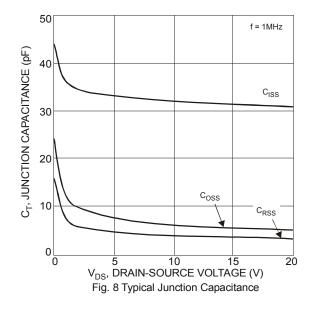
N-CHANNEL - Q1



Gate-Source Voltage

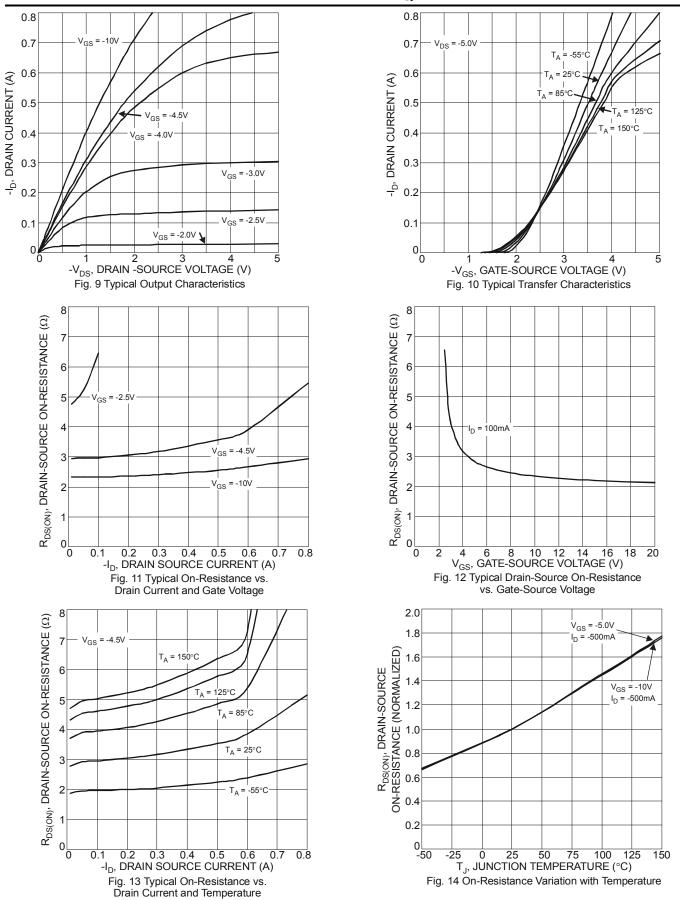




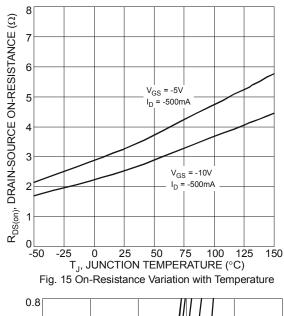


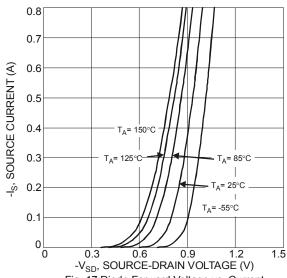


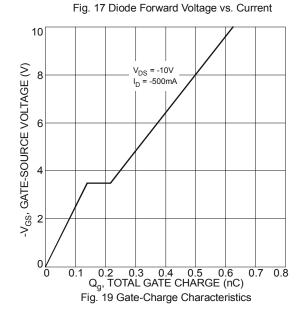
P-CHANNEL - Q2











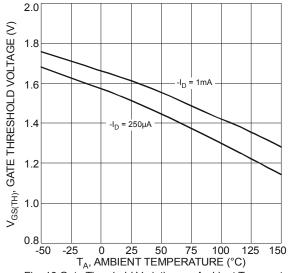
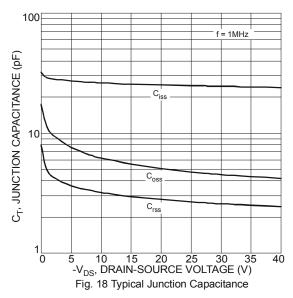


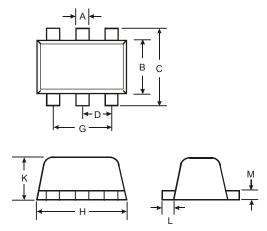
Fig. 16 Gate Threshold Variation vs. Ambient Temperature





Package Outline Dimensions

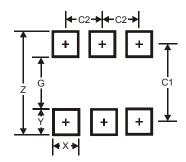
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT563							
Dim	Min Max Typ						
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
М	0.10	0.18	0.11				
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
X	0.375
Y	0.5
C1	1.7
C2	0.5



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